74LVC125A

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

Rev. 7 — 11 April 2013

Product data sheet

1. General description

The 74LVC125A consists of four non-inverting buffers/line drivers with 3-state outputs (nY) that are controlled by the output enable input (nOE). A HIGH at nOE causes the outputs to assume a high-impedance OFF-state.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs.

2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ◆ HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - ◆ CDM JESD22-C101E exceeds 1000 V
- Multiple package options
- Specified from −40 °C to +85 °C and −40 °C to +125 °C



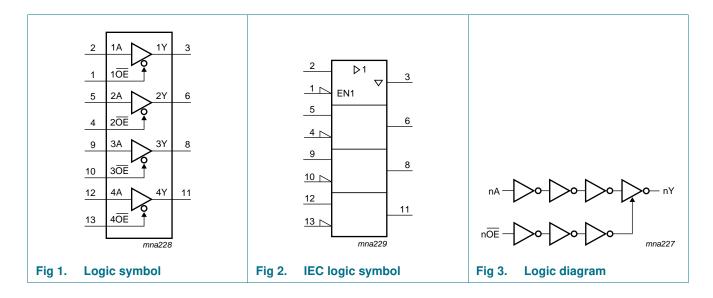
Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC125AD	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm; body thickness 1.47 mm	SOT108-1
74LVC125ADB	–40 °C to +125 °C	SSOP14	plastic shrink small outline package; 14 leads; body width 5.3 mm	SOT337-1
74LVC125APW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
74LVC125ABQ	−40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 \times 3 \times 0.85 mm	SOT762-1

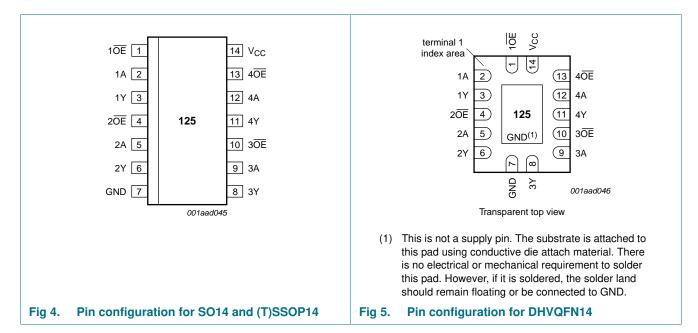
4. Functional diagram



Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

	p area.	
Symbol	Pin	Description
1 OE , 2 OE , 3 OE , 4 OE	1, 4, 10, 13	data enable input (active LOW)
1A, 2A, 3A, 4A	2, 5, 9, 12	data input
1Y, 2Y, 3Y, 4Y	3, 6, 8, 11	data output
GND	7	ground (0 V)
V _{CC}	14	supply voltage

6. Functional description

Table 3. Function selection[1]

Inputs nOE		Output
nOE	nA	nY
L	L	L
L	Н	Н
Н	X	Z

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
V_{I}	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0$ V	-	±50	mA
V_{O}	output voltage	output HIGH or LOW-state	[<u>2</u>] –0.5	$V_{CC} + 0.5$	V
		output 3-state	[<u>2</u>] –0.5	+6.5	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I_{GND}	ground current		-100	-	mA
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	[3] _	500	mW
T_{stg}	storage temperature		-65	+150	°C

^[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V_{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature		-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and	V _{CC} = 2.3 V to 2.7 V	0	-	20	ns/V
	fall rate	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	0	-	10	ns/V

^[2] The output voltage ratings may be exceeded if the output current ratings are observed.

^[3] For SO14 packages: above 70 °C derate linearly with 8 mW/K.
For (T)SSOP14 packages: above 60 °C derate linearly with 5.5 mW/K.
For DHVQFN14 packages: above 60 °C derate linearly with 4.5 mW/K.

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	35 °C	–40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	V V V V V V V V V V V V V V V V V V V
V_{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V_{IL}	LOW-level input	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	-	0.7	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V
V_{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \ to \ 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_O = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_O = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_O = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V_{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	-	-	0.2	-	0.3	V
		$I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_O = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	8.0	V
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	8.0	V
l _l	input leakage current	$V_{CC} = 3.6 \text{ V}; V_I = 5.5 \text{ V or GND}$	-	±0.1	±5	-	±20	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 3.6 \text{ V}$; $V_O = 5.5 \text{ V}$ or GND	-	±0.1	±5	-	±20	μΑ
I _{OFF}	power-off leakage current	V_{CC} = 0.0 V; V_{I} or V_{O} = 5.5 V	-	±0.1	±10	-	±20	μΑ
I _{CC}	supply current	$V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND};$ $I_O = 0 \text{ A}$	-	0.1	10	-	40	μΑ
ΔI_{CC}	additional supply current	per input pin; $V_I = V_{CC} - 0.6 \text{ V}$; $I_O = 0 \text{ A}$; $V_{CC} = 2.7 \text{ V}$ to 3.6 V	-	5	500	-	5000	μΑ
Cı	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$	-	4.0	-	-	-	pF

^[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	nA to nY; see Figure 6	[2]						'
		V _{CC} = 1.2 V		-	12.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	5.4	11.0	1.5	12.8	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	2.9	5.7	1.0	6.7	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	2.8	5.5	1.5	7.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.5	4.8	1.0	6.0	ns
t _{en}	enable time	nOE to nY; see Figure 7	[2]						
		V _{CC} = 1.2 V		-	16.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.0	5.0	12.2	1.0	14.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.5	2.9	6.8	0.5	7.9	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	3.1	6.6	1.5	8.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.3	5.4	1.0	7.0	ns
t _{dis}	disable time	nOE to nY; see Figure 7	[2]						
		$V_{CC} = 1.2 V$		-	7.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.2	4.6	7.5	2.2	8.7	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.5	2.6	4.2	0.5	5.0	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	3.1	5.0	1.5	6.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	3.2	4.6	1.0	6.0	ns
t _{sk(o)}	output skew time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns
C_{PD}	power dissipation	per buffer; $V_I = GND$ to V_{CC}	[4]						
	capacitance	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		-	6.0	-	-	-	рF
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	9.4	-	-	-	pF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	12.4	-	-	-	pF

^[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

$$P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}{}^2 \times f_o)$$
 where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

^[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

ten is the same as tPZL and tPZH.

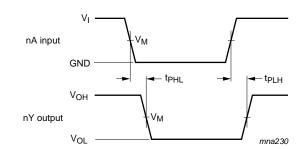
 t_{dis} is the same as t_{PLZ} and t_{PHZ} .

^[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

^[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

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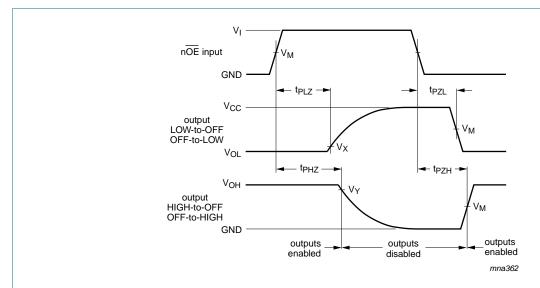
11. AC waveforms



Measurement points are given in Table 8.

 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 6. The input nA to output nY propagation delays



Measurement points are given in <u>Table 8</u>.

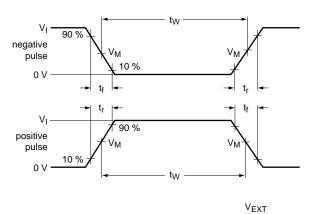
 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

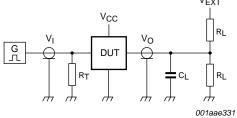
Fig 7. 3-state enable and disable times

Table 8. Measurement points

Supply voltage	Input		Output	
V _{CC}	VI	V _M	V _M	
1.2 V	V _{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{\text{CC}}$	
1.65 V to 1.95 V	V_{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	
2.3 V to 2.7 V	V_{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	
2.7 V	2.7 V	1.5 V	1.5 V	
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state





Test data is given in Table 9.

Definitions for test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 8. Test circuit for measuring switching times

Table 9. Test data

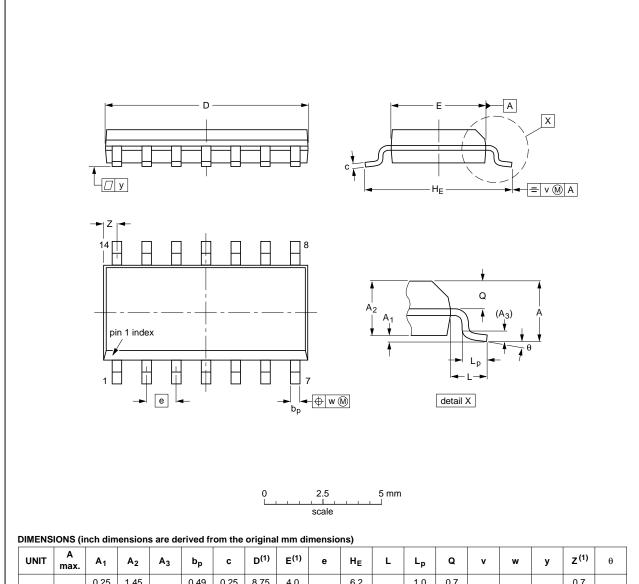
Supply voltage	Input		Load		V _{EXT}	V _{EXT}				
	VI	t _r , t _f	CL	R_L	t _{PLH} , t _{PHL}	t_{PLZ}, t_{PZL}	t_{PHZ} , t_{PZH}			
1.2 V	V_{CC}	≤ 2 ns	30 pF	1 k Ω	open	$2\times V_{CC}$	GND			
1.65 V to 1.95 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND			
2.3 V to 2.7 V	V_{CC}	≤ 2 ns	30 pF	500Ω	open	$2\times V_{CC}$	GND			
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND			
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	50 pF 500 Ω		$2\times V_{CC}$	GND			

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

12. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.35 0.34	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016		0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

	REFER	ENCES	EUROPEAN	ISSUE DATE
IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
076E06	MS-012			99-12-27 03-02-19
	-	IEC JEDEC	IEC JEDEC JEITA	IEC JEDEC JEITA PROJECTION

Fig 9. Package outline SOT108-1 (SO14)

74LVC125A

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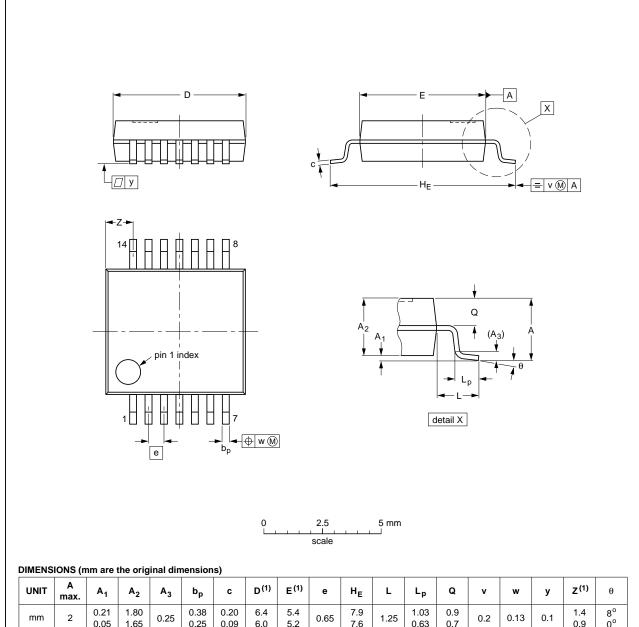
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74LVC125A **NXP Semiconductors**

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



- 3							-,												
	UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
	mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.4 0.9	8° 0°

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	IOOUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT337-1		MO-150				-99-12-27 03-02-19

Fig 10. Package outline SOT337-1 (SSOP14)

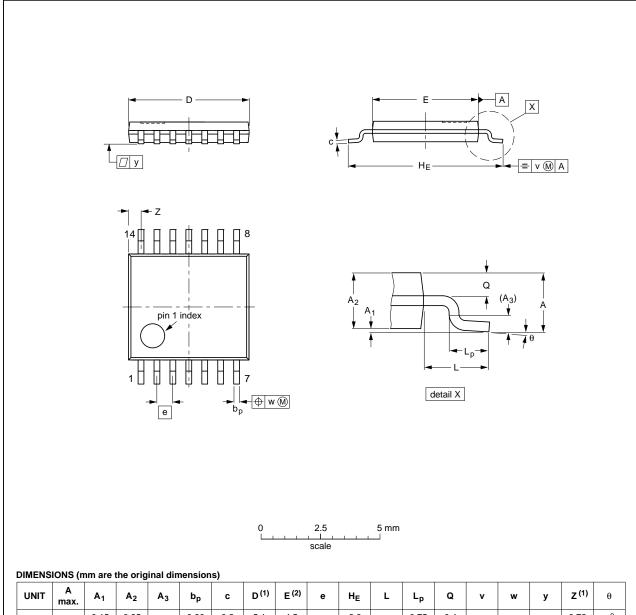
74LVC125A

74LVC125A **NXP Semiconductors**

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



ι	JNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	ď	٧	w	у	Z ⁽¹⁾	θ
	mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT402-1		MO-153				99-12-27 03-02-18

Fig 11. Package outline SOT402-1 (TSSOP14)

74LVC125A

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Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

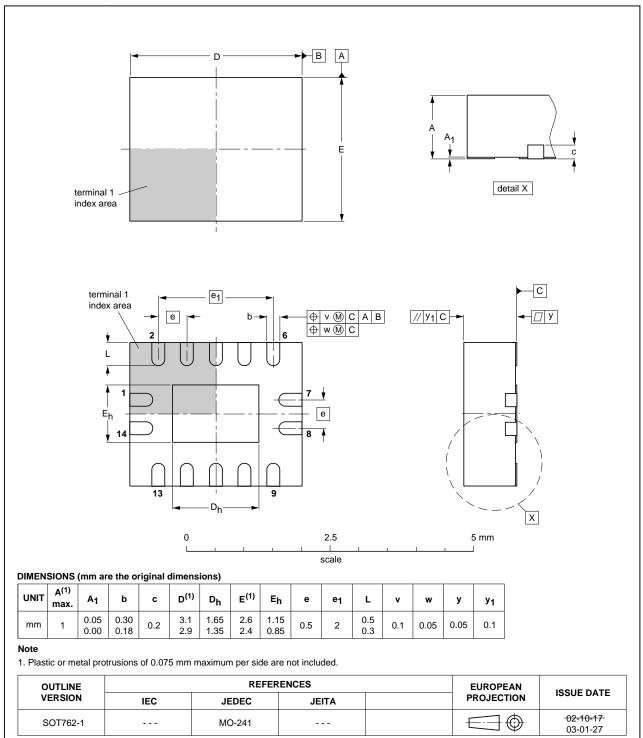


Fig 12. Package outline SOT762-1 (DHVQFN14)

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Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

13. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
MM	Machine Model
HBM	Human Body Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history

	•			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC125A v.7	20130411	Product data sheet	-	74LVC125A v.6
Modifications:	 Features list continued 	orrected (errata)		
74LVC125A v.6	20130305	Product data sheet	-	74LVC125A v.5
74LVC125A v.5	20120208	Product data sheet	-	74LVC125A v.4
74LVC125A v.4	20030507	Product specification	-	74LVC125A v.3
74LVC125A v.3	20020308	Product specification	-	74LVC125A v.2
74LVC125A v.2	19980428	Product specification	-	74LVC125A v.1
74LVC125A v.1	19970801	Product specification	-	-

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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